

LST-TIP-204

Description

LISAT LST-TIP-204 is a Thermal Pad with good surface wetting ability and high thermal conductivity. It is able to produce excellent performance. The softness of the material has an ideal blend that allows it to achieve a low interface thermal impedance at low pressure level and yet maintains optimal thermal performance. With good recoverability, it's able to provide rebounding force to ensure a reliable contact thus allowing effective thermal dissipation from heat source through gap filled by removing air to its best ability.



Features and Benefits

- Thermal Conductivity < 1
- Low Thermal Impedance
- Good Electrical Insulation
- Low Hardness
- Elasticity for Reliable Long Term Work
- Wide Thickness Range

Typical Applications

- @ CPU, GPU & VGA High Power Chips
- @ Telecommunication
- @ Power Semiconductors
- @ Display Equipment Cooling Application
- @ Power Semiconductors

Properties

Note: Below technical data and information should be thought as typical or representative only and should not be use for specification purpose

TYPICAL PROPERTIES OF THERMAL INSULATOR LST-TIP-204						
PROPERTY	IMPERIAL VALUE		METRIC VALUE		REFERENT STANDARD	
Color	Purple		Purple		Visual	
Density (g/cc)	3.00		3.00		N/A	
Thickness (mils)/(mm)	20 ~ 200		0.5 ~ 5.0		ASTM D374	
Hardness (Shore 00)	55		55		ASTM D2240	
Continous Use Temp (°F)/(°C)	-49 to 392		-45 to 200		N/A	
ELECTRICAL						
Dielectric Breakdown Vloltage (KV/mm)	10		10		ASTM D149	
Volume Resistivity (Ω-meter)	9.6x10 ¹²		9.6x10 ¹²		ASTM D257	
Flame Rating	V-O		V-O		UL94	
THERMAL						
Thermal Conductivity (W/m-K)	1.2		1.2		ASTM5470	
THERMAL PERFORMANCE vs PRESSURE (1 mm)						
Pressure (psi)	2	5	10	20	30	40
Thermal Impedance (K-m²/W)	0.000845	0.000742	0.000658	0.000613	0.000587	0.000561
Thermal Impedance (°C-in²/W)	1.31	1.15	1.02	0.95	0.91	0.87
Compression Rate (%)	4%	10%	17%	22%	27%	30%

LISAT

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